
2SC2735

Silicon NPN Epitaxial

HITACHI

ADE-208-1075 (Z)

1st. Edition

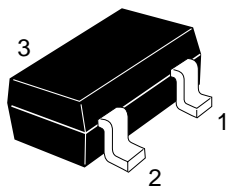
Mar. 2001

Application

UHF/VHF Local oscillator, frequency converter

Outline

MPAK



- 1. Emitter
- 2. Base
- 3. Collector

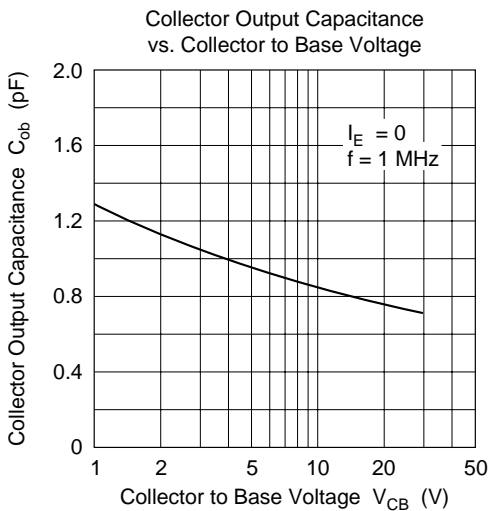
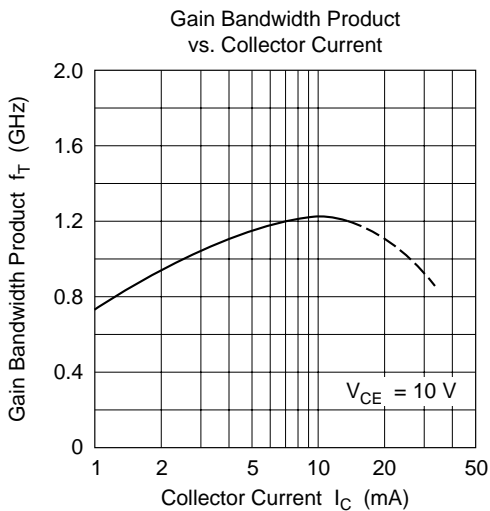
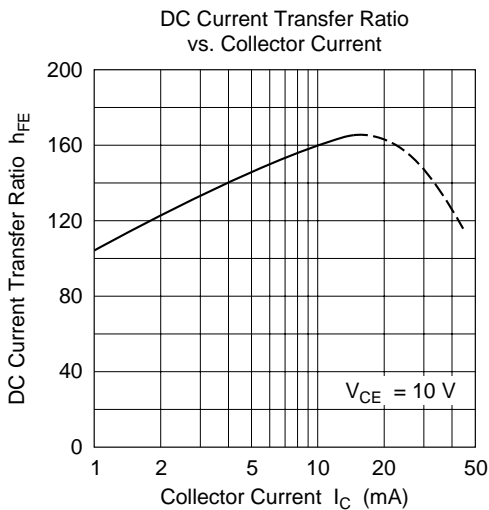
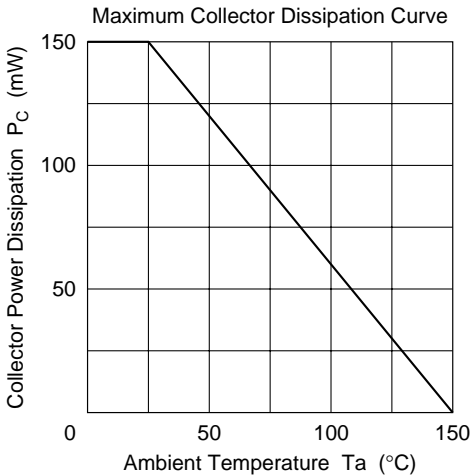
Note: Marking is "JC".

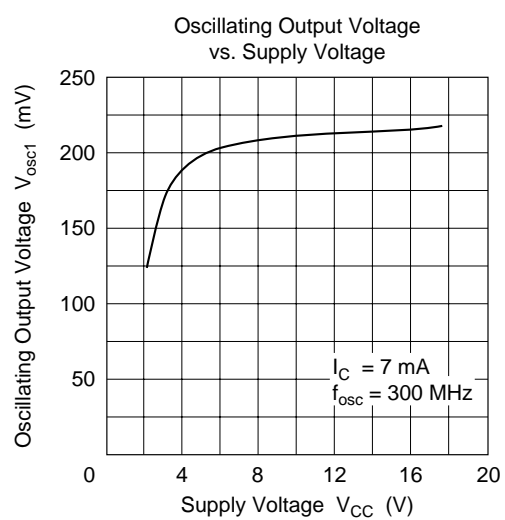
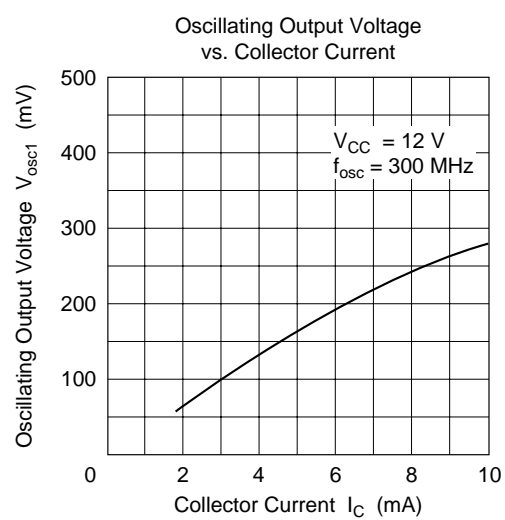
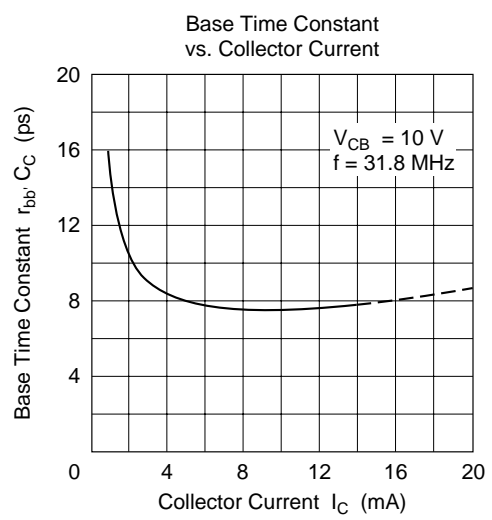
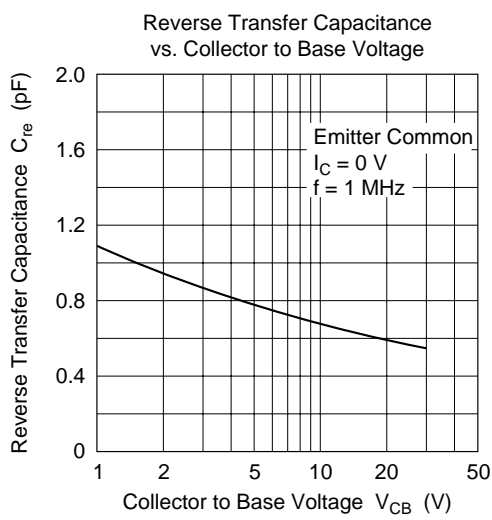
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Item | Symbol | Ratings | Unit |
|------------------------------|------------------|-------------|------------------|
| Collector to base voltage | V_{CBO} | 30 | V |
| Collector to emitter voltage | V_{CEO} | 20 | V |
| Emitter to base voltage | V_{EBO} | 3 | V |
| Collector current | I_{C} | 50 | mA |
| Collector power dissipation | P_{C} | 150 | mW |
| Junction temperature | T_{j} | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

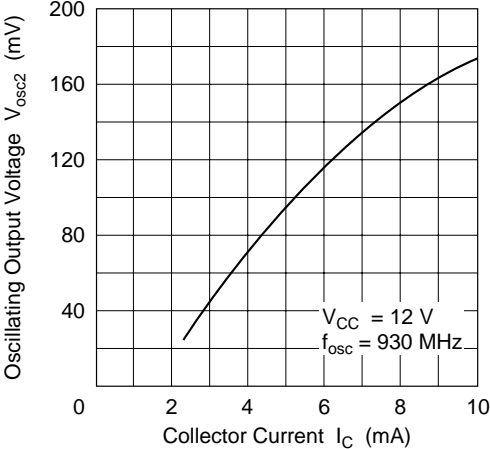
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|---|-----------------------------|-----|------|-----|---------------|--|
| Collector to base breakdown voltage | $V_{(\text{BR})\text{CBO}}$ | 30 | — | — | V | $I_{\text{C}} = 10\text{ }\mu\text{A}$, $I_{\text{E}} = 0$ |
| Collector to emitter breakdown voltage | $V_{(\text{BR})\text{CEO}}$ | 20 | — | — | V | $I_{\text{C}} = 1\text{ mA}$, $R_{\text{BE}} = \infty$ |
| Emitter to base breakdown voltage | $V_{(\text{BR})\text{EBO}}$ | 3 | — | — | V | $I_{\text{E}} = 10\text{ }\mu\text{A}$, $I_{\text{C}} = 0$ |
| Collector cutoff current | I_{CBO} | — | — | 0.5 | μA | $V_{\text{CB}} = 10\text{ V}$, $I_{\text{C}} = 0$ |
| Collector to emitter saturation voltage | $V_{\text{CE}(\text{sat})}$ | — | — | 1.0 | V | $I_{\text{C}} = 20\text{ mA}$, $I_{\text{B}} = 4\text{ mA}$ |
| DC current transfer ratio | h_{FE} | 40 | — | — | | $V_{\text{CE}} = 10\text{ V}$, $I_{\text{C}} = 10\text{ mA}$ |
| Collector output capacitance | C_{ob} | — | 0.85 | 1.5 | pF | $V_{\text{CB}} = 10\text{ V}$, $I_{\text{E}} = 0$, $f = 1\text{ MHz}$ |
| Gain bandwidth product | f_{T} | 600 | 1200 | — | MHz | $V_{\text{CE}} = 10\text{ V}$, $I_{\text{C}} = 10\text{ mA}$ |
| Oscillating output voltage | V_{OSC1} | — | 210 | — | mV | $V_{\text{CC}} = 12\text{ V}$, $I_{\text{C}} = 7\text{ mA}$, $f_{\text{OSC}} = 300\text{ MHz}$ |
| | V_{OSC2} | — | 130 | — | mV | $V_{\text{CC}} = 12\text{ V}$, $I_{\text{C}} = 7\text{ mA}$, $f_{\text{OSC}} = 930\text{ MHz}$ |
| Conversion gain | CG | — | 21 | — | dB | $V_{\text{CC}} = 12\text{ V}$, $I_{\text{C}} = 2\text{ mA}$, $f = 200\text{ MHz}$, $f_{\text{OSC}} = 230\text{ MHz}$ (0dBm) |
| Noise figure | NF | — | 6.5 | — | dB | $V_{\text{CC}} = 12\text{ V}$, $I_{\text{C}} = 2\text{ mA}$, $f = 200\text{ MHz}$, $f_{\text{OSC}} = 230\text{ MHz}$ (0dBm) |

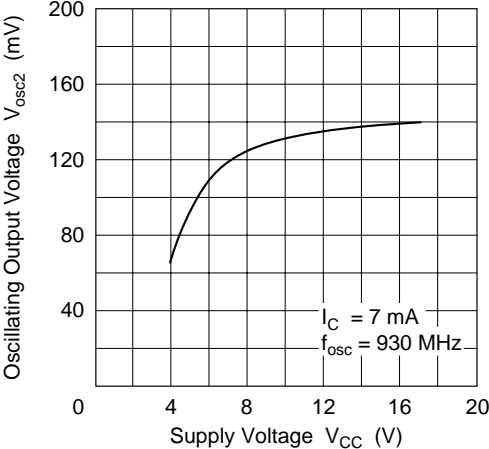




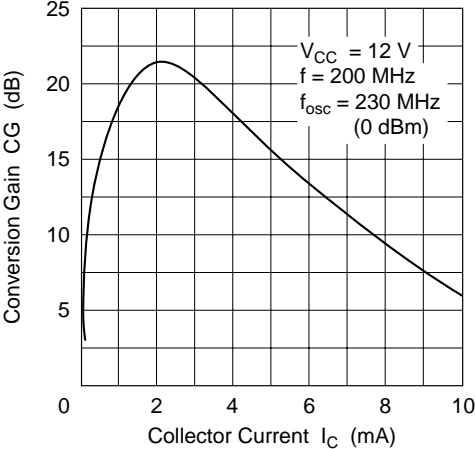
Oscillating Output Voltage
vs. Collector Current



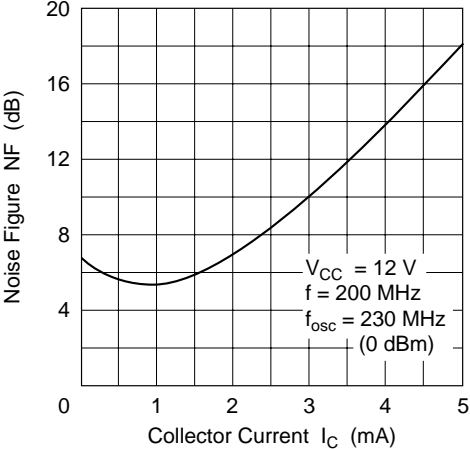
Oscillating Output Voltage
vs. Supply Voltage



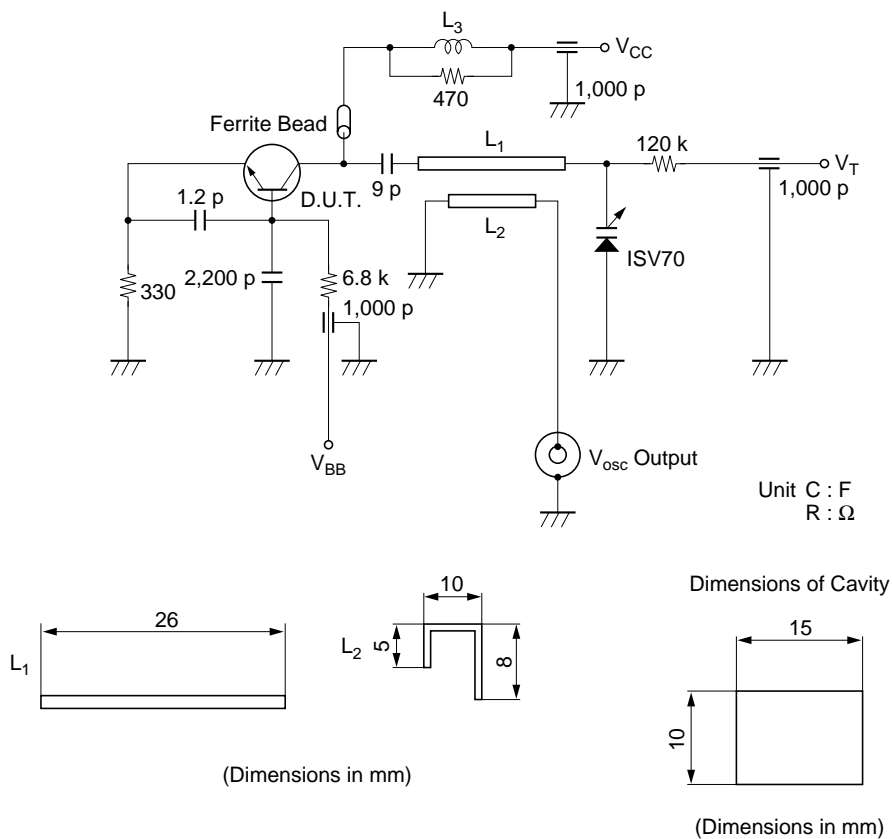
Conversion Gain vs. Collector Current



Noise Figure vs. Collector Current



V_{OSC2} UHF Oscillating Output Voltage Test Circuit



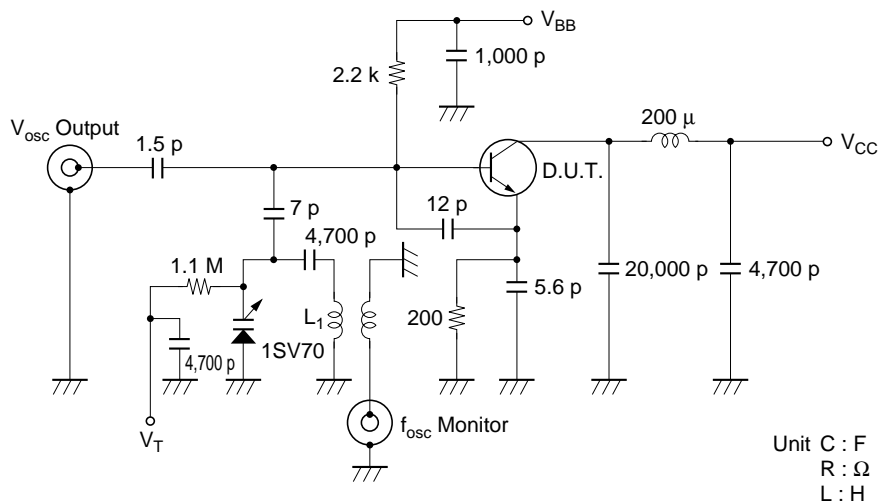
L_1 : Polyurethane Coated Copper Wire $\phi 1.0$ mm

L_2 : Polyurethane Coated Copper Wire $\phi 0.8$ mm

L_3 : $\phi 0.3$ mm Enameled Copper wire, 10 Turns with 470Ω (1/4W) Resistor.

Test Frequency : $f_{osc} = 930$ MHz

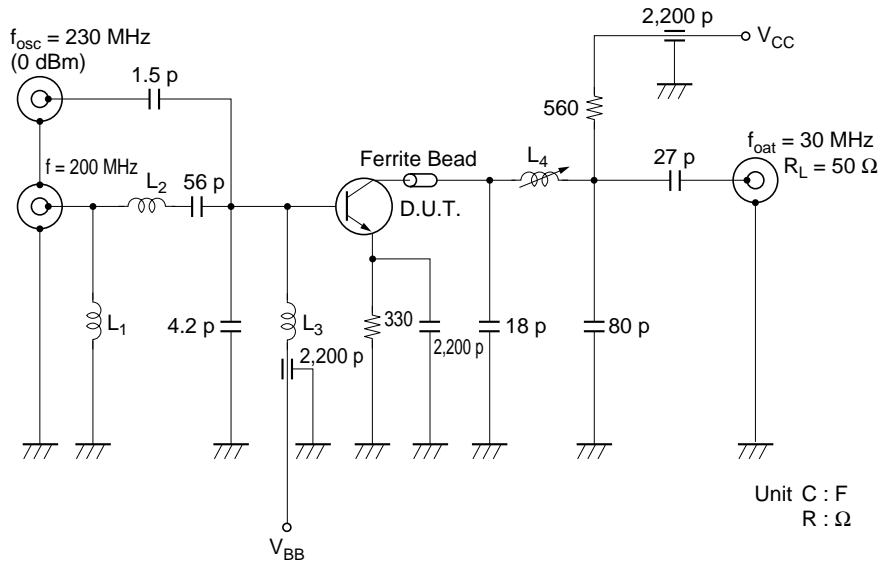
Test Equipment : YHP 4271A Vector Voltmeter

V_{OSC1} VHF Oscillating Output Voltage Test Circuit

L₁ : Inside dia $\phi 3$ mm, $\phi 3$ mm Enameled Copper Wire 12 Turns

Test Frequency : f_{osc} = 300 MHz

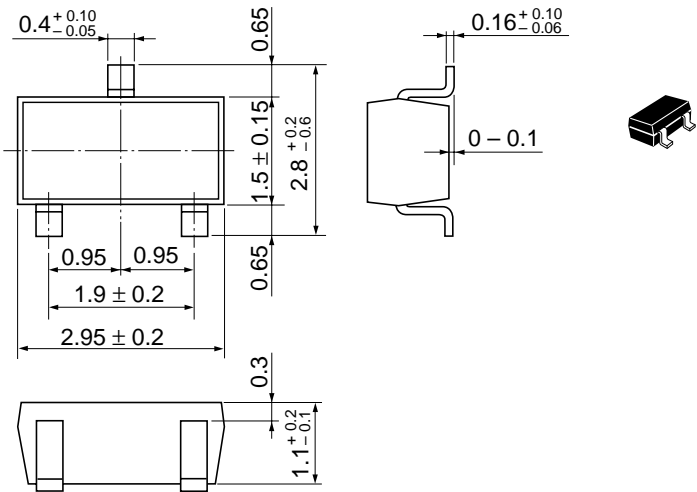
VHF Conversion Gain : Noise Figure Test Circuit



- L_1 : Inside dia $\phi 5 \text{ mm}$, $\phi 0.5 \text{ mm}$ Enameled Copper Wire 4 Turns
- L_2 : Inside dia $\phi 4 \text{ mm}$, $\phi 0.5 \text{ mm}$ Enameled Copper Wire 4 Turns
- L_3 : Inside dia $\phi 3 \text{ mm}$, $\phi 0.2 \text{ mm}$ Enameled Copper Wire 6 Turns
- L_4 : Outside dia $\phi 5 \text{ mm}$ Bobbin, $\phi 0.2 \text{ mm}$ Enameled Copper Wire 16 Turns, using Ferrite bead.

Package Dimensions

As of January, 2001
Unit: mm



| | |
|------------------------|----------|
| Hitachi Code | MPAK |
| JEDEC | — |
| EIAJ | Conforms |
| Mass (reference value) | 0.011 g |

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